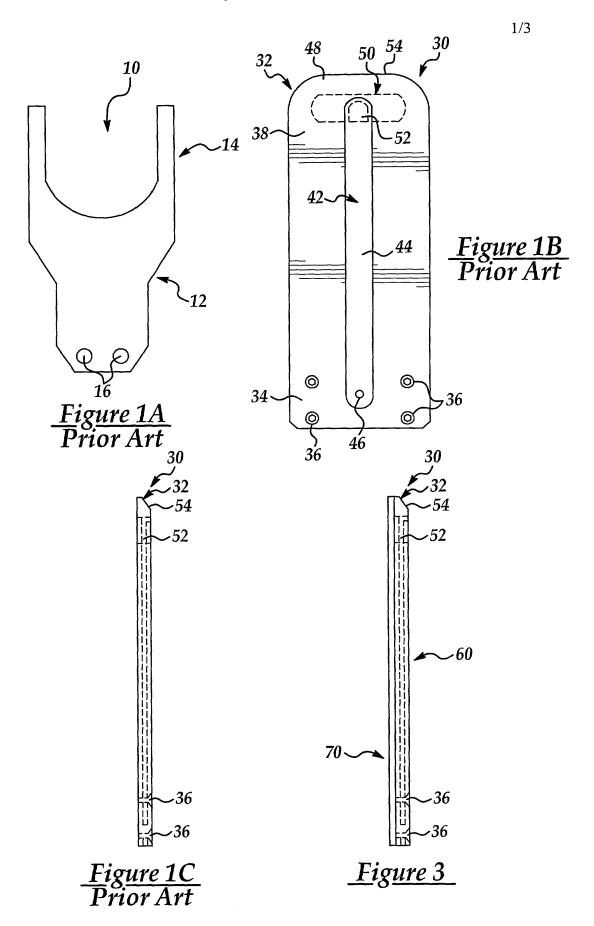
Inventor(s): Hsu Serial No.: To Be Assigned Filed: Herewith

For: Wafer Blade Equipped With Piezoelectric Sensors

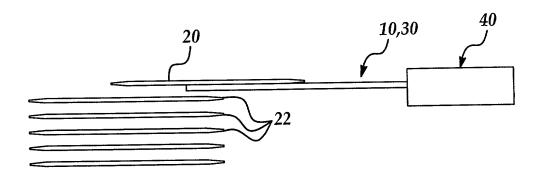
Attorney Docket No.: 67,200-531



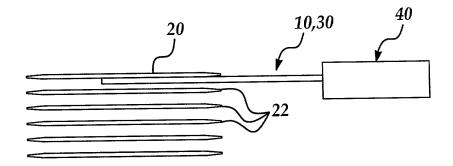
Inventor(s): Hsu Serial No.: To Be Assigned Filed: Herewith

For: Wafer Blade Equipped With Piezoelectric Sensors Attorney Docket No.: 67,200-531

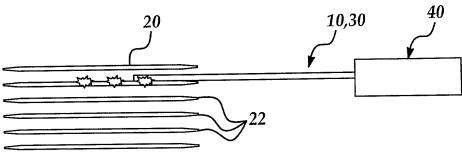




<u>Figure 2A</u> Prior Art



<u>Figure 2B</u> Prior Art



<u>Figure 2C</u> Prior Art

Inventor(s): Hsu
Serial No.: To Be Assigned
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or: Wafer Blade Equipped With Piezoelectric Sensors Attorney Docket No.: 67,200-531

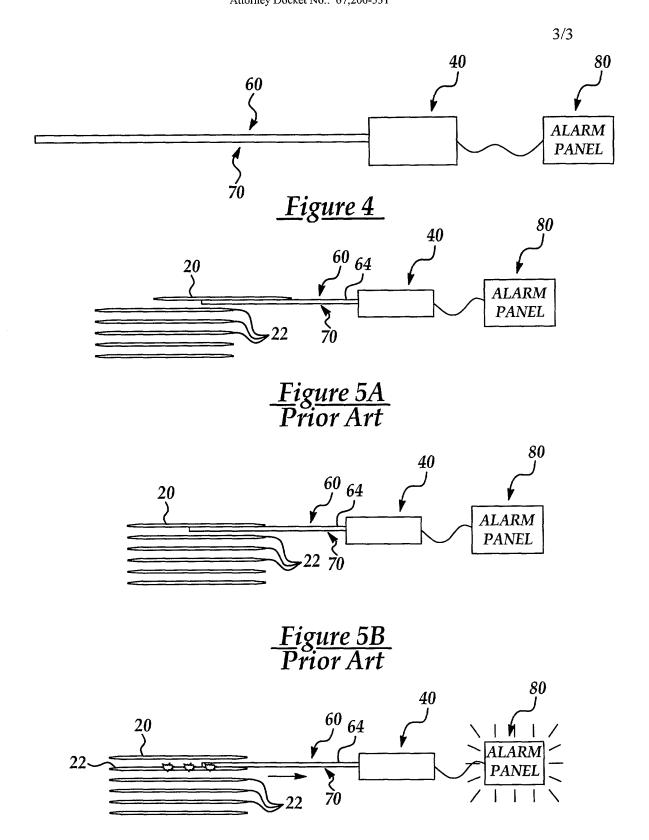


Figure 5C Prior Art